

MOSFET

OptiMOS[™] 5 Power-Transistor, 60 V

Features

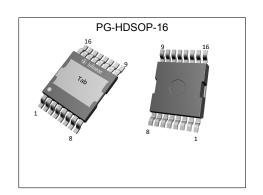
- Optimized for motor drives and battery powered applications
- Optimized for top side coolingHigh current capability
- 175°C rated
- 100% avalanche tested
- Superior thermal performance
- N-Channel
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

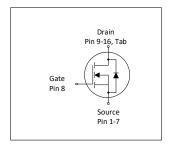


Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit	
V _{DS}	60	V	
R _{DS(on),max}	1.2	mΩ	
I _D	311	A	
Qoss	119	nC	
Q _G	106	nC	











Type / Ordering Code	Package	Marking	Related Links
IPTC012N06NM5	PG-HDSOP-16	12N06NM5	-

OptiMOS[™] 5 Power-Transistor, 60 V



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OptiMOS[™] 5 Power-Transistor, 60 V IPTC012N06NM5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Danamastan	0	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	- - -	311 220 170 41	A	V_{GS} =10 V, T_{C} =25 °C V_{GS} =10 V, T_{C} =100 °C V_{GS} =6 V, T_{C} =100 °C V_{GS} =10 V, T_{A} =25°C, R_{thJA} =40°C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1244	Α	<i>T</i> _A =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	420	mJ	$I_{\rm D}$ =100 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	214 3.8	W	T _C =25 °C T _A =25 °C, R _{thJA} =40 °C/W ²)
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	-

2 Thermal characteristics

Table 3 Thermal characteristics

Davamatar	Cymbol	Values			l lmi4	Note / Test Candition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case, top	R _{thJC}	-	0.4	0.7	°C/W	-	
Thermal characterization parameter, junction to lead (Pin 1-7) ⁵⁾	Ψ_{JL}	-	9	-	°C/W	-	
Thermal characterization parameter, junction to lead (Pin 9-16) ⁵⁾	Ψ_{JL}	-	3	-	°C/W	-	
Thermal resistance, junction - ambient ²⁾	R _{thJA}	_	40	_	°C/W	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

⁵⁾ Ψ_{JL} is a temperature characterization parameter according to JESD51-12 referring to the temperature difference between junction and leads in the case of natural convection. It can be used to estimate the component junction temperature in the application by measuring the temperature at the leads in the stated application environment

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Static characteristics Table 4

Damamatan	Oh al		Values			N / / T / O III	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	60	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA	
Gate threshold voltage	V _{GS(th)}	2.1	2.8	3.3	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 143 \ \mu {\rm A}$	
Zero gate voltage drain current	I _{DSS}	-	0.5 10	1.0 100	μΑ	V _{DS} =60 V, V _{GS} =0 V, T _j =25 °C V _{DS} =60 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	1.08 1.45	1.2 2.0	mΩ	V _{GS} =10 V, I _D =100 A V _{GS} =6 V, I _D =50 A	
Gate resistance ¹⁾	R _G	-	1.6	2.4	Ω	-	
Transconductance	g fs	115	230	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 100 A$	

Table 5 **Dynamic characteristics**

Developed	Crossbal		Values	;		Nata / Tank Oan dittion	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance	C _{iss}	-	7800	10000	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz	
Output capacitance ¹⁾	Coss	-	1800	2300	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz	
Reverse transfer capacitance ¹⁾	C _{rss}	-	69	120	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	16	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 Ω	
Rise time	t _r	-	27	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 Ω	
Turn-off delay time	$t_{ m d(off)}$	-	48	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 Ω	
Fall time	t _f	-	23	-	ns	$V_{\rm DD} = 30 \text{ V}, V_{\rm GS} = 10 \text{ V}, I_{\rm D} = 100 \text{ A}, R_{\rm G,ext} = 1.8 \Omega$	

Gate charge characteristics²⁾ Table 6

Doromotor	Symbol		Values			Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	35	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	22	-	nC	V _{DD} =30 V, I _D =100 A, V _{GS} =0 to 10 V
Gate to drain charge ¹⁾	Q _{gd}	-	19	29	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	32	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Qg	-	106	133	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.5	-	V	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	94	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	119	158	nC	V _{DS} =30 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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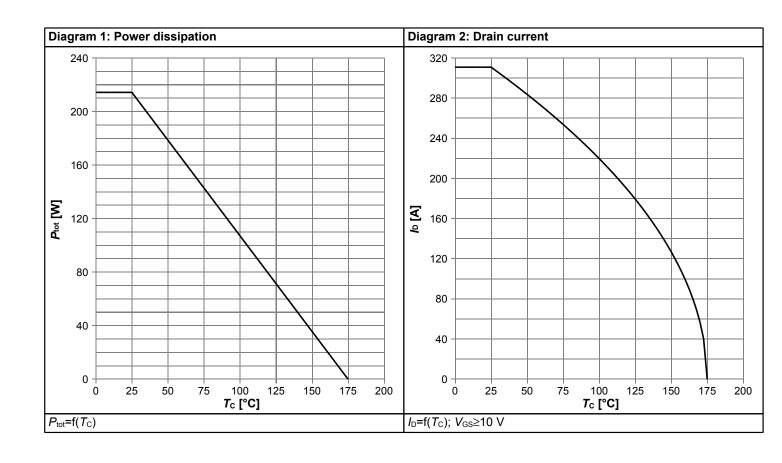


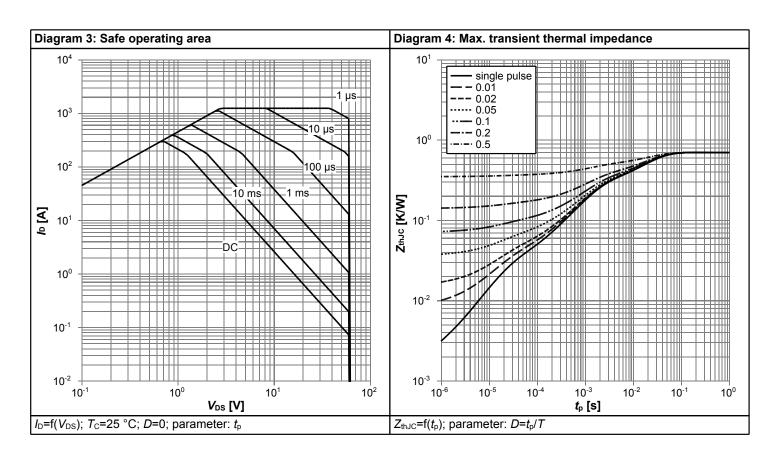
Table 7 Reverse diode

Davamatav	Cumbal	Values			11	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	194	Α	T _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	1244	Α	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	0.9	1.0	V	V _{GS} =0 V, I _F =100 A, T _j =25 °C	
Reverse recovery time ¹⁾	t _{rr}	-	90	180	ns	V _R =30 V, I _F =100 A, di _F /dt=100 A/μs	
Reverse recovery charge ¹⁾	Qrr	-	237	474	nC	V _R =30 V, I _F =100 A, d <i>i</i> _F /d <i>t</i> =100 A/μs	

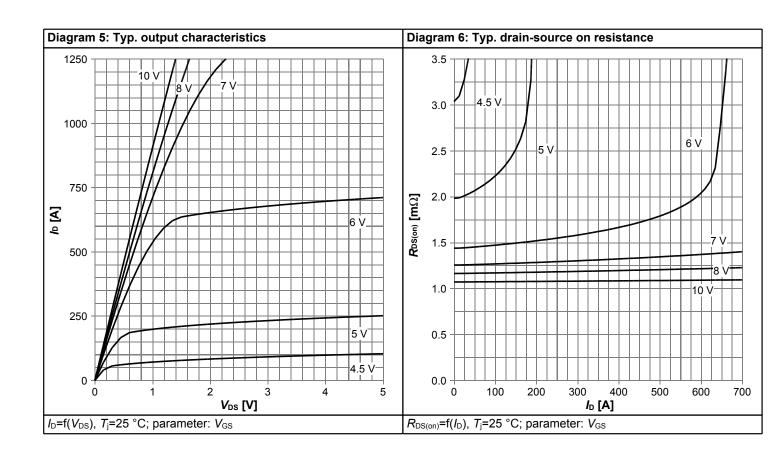


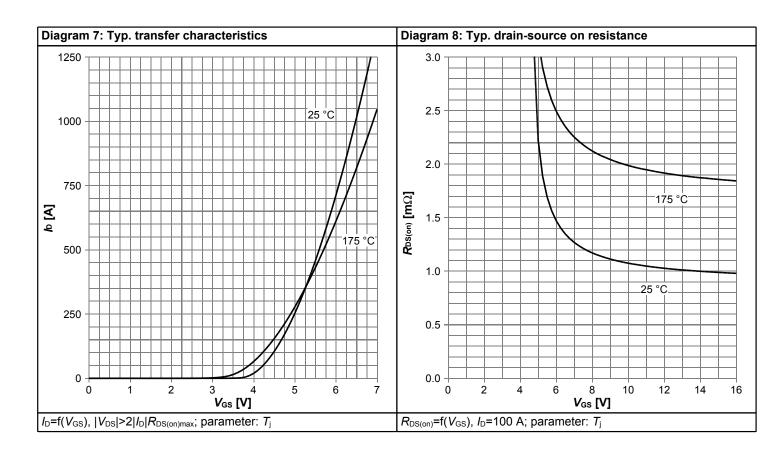
4 Electrical characteristics diagrams



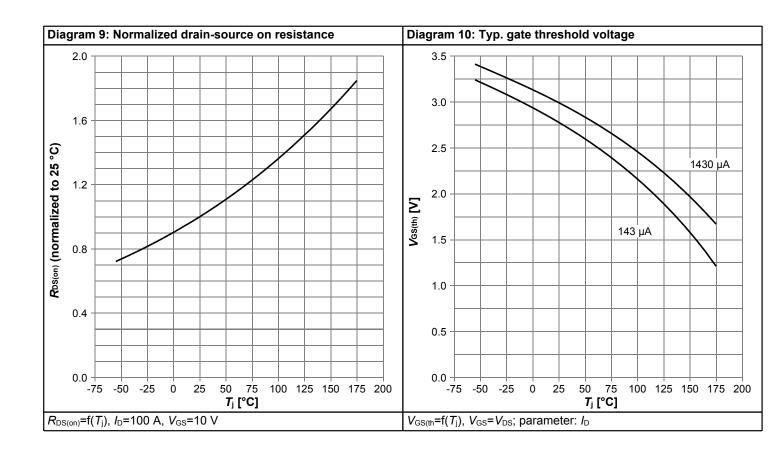


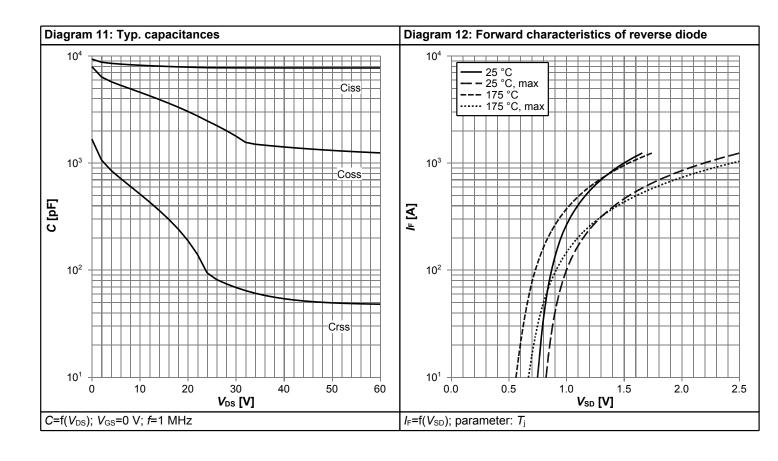




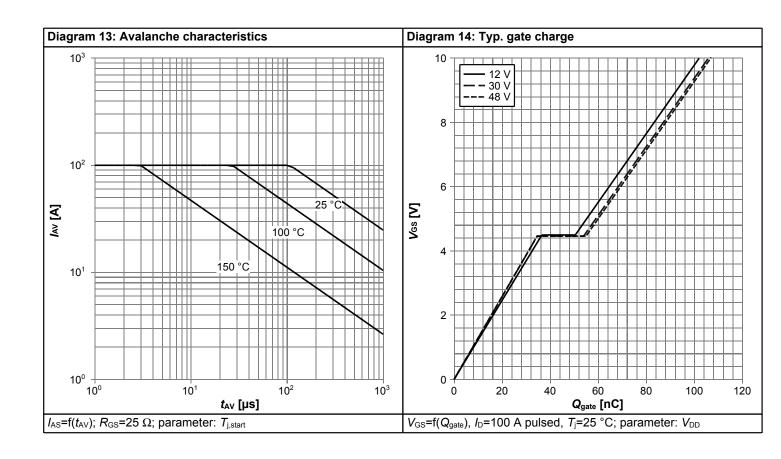


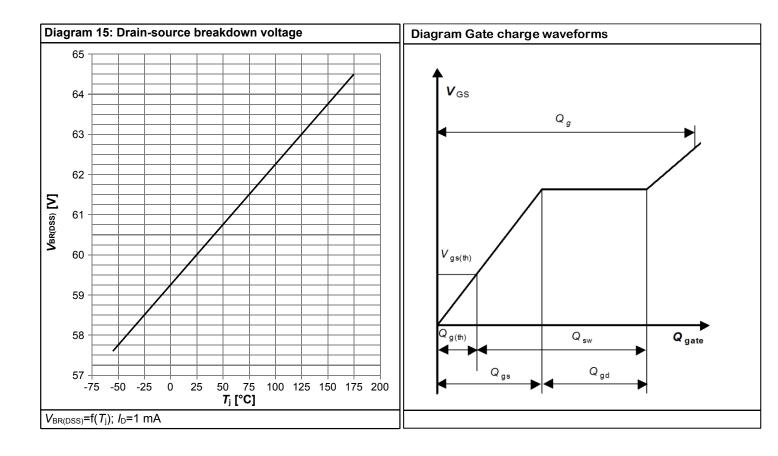






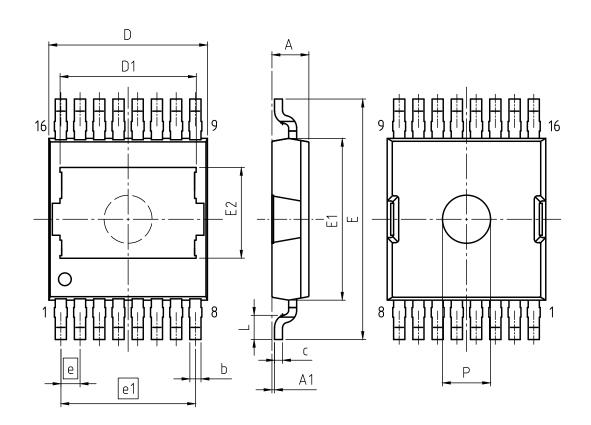








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-HDSOP-16-U01				
REVISION: 01	DATE:	18.12.2020			
DIMENSIONS	MILLIM	ETERS			
DIMENSIONS	MIN.	MAX.			
Α	2.25	2.35			
A1	0.01	0.16			
b	0.60	0.80			
С	0.40	0.60			
D	9.70	10.10			
D1	8.20	8.40			
E	14.80	15.20			
E1	10.00	10.30			
E2	5.57	5.77			
е	1.20				
e1	8.40				
L	1.40	1.60			
P	2.90	3.10			

Figure 1 Outline PG-HDSOP-16, dimensions in mm

OptiMOS[™] 5 Power-Transistor, 60 V IPTC012N06NM5



Revision History

IPTC012N06NM5

Revision: 2022-09-27, Rev. 2.0

Previous Revision

1 Tevious IX	CVISIOII	
Revision	Date	Subjects (major changes since last revision)
2.0	2022-09-27	Release of final version

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Final Data Sheet 11 Rev. 2.0, 2022-09-27